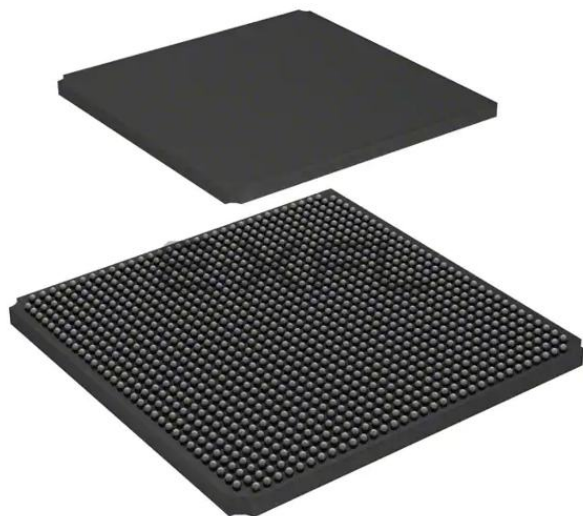




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	20000
Number of Logic Elements/Cells	80000
Total RAM Bits	5816320
Number of I/O	660
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga80e-7fcn1152c

Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the PURESPEED I/O buffers. The block contains a register for SDR operation and a group of three registers for DDR and shift register operation. The output signal tri-state control signal (TO) can be derived directly from one of the inputs (bypass mode), the SDR shift register, the DDR registers or the data associated with the buffer (for open drain emulation). Figure 2-24 shows the diagram of the Tristate Register Block.

Tristate SDR Register/Latch Block

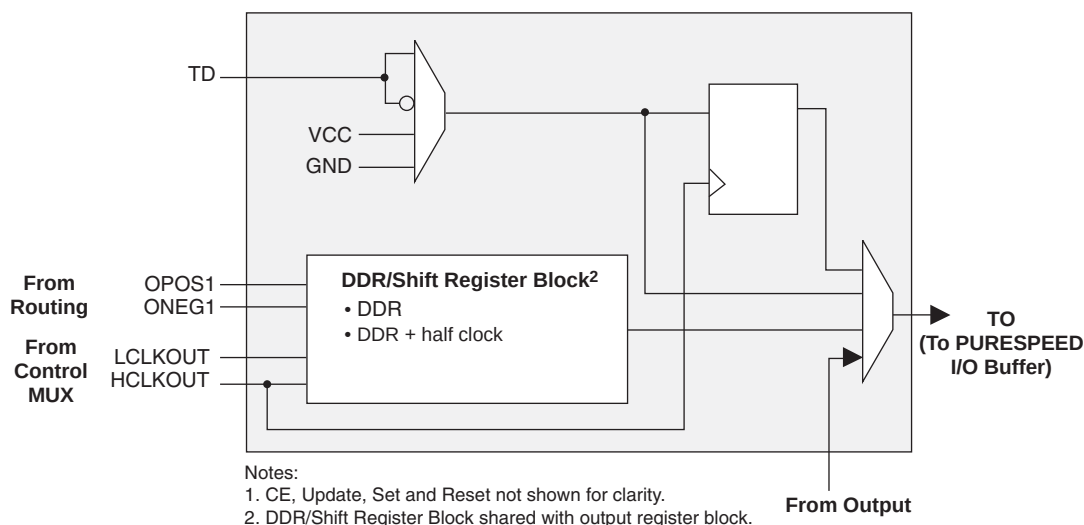
The SDR register operates on the positive edge of the high-speed clock. In it has a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR and Global Set Reset GSR enable or disable. The register LSR input is driven from LSRO, which is generated from the PIO control MUX. The GSR input is driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Tristate DDR/Shift Register Block

The DDR/Shift block is shared with the output block allowing DDR support using the high-speed clock and the associated transfer from the low-speed clock domain. It functions as a gearbox allowing low-speed parallel data from the FPGA fabric to provide a high-speed tri-state control stream.

There is a special mode for DDR-II memory interfaces where the termination is controlled by the output tristate signal. During WRITE cycle when the FPGA is driving the lines, the parallel terminations are turned off. During READ cycle when the FPGA is receiving data, the parallel terminations are turned on.

Figure 2-24. Tristate Register Block¹



I/O Architecture Rules

Table 2-6 shows the PIO usage for x1, x2, x4 gearing. The checkmarks in the columns show the specific PIOs that are used for each gearing mode. When using x2 or x4 gearing, any PIO which is not used for gearing can still be used as an output.

PURESPEED I/O Buffer Banks

LatticeSC devices have seven PURESPEED I/O buffer banks; each is capable of supporting multiple I/O standards. Each PURESPEED I/O bank has its own I/O supply voltage (V_{CCIO}), and two voltage references V_{REF1} and V_{REF2} resources allowing each bank to be completely independent from each other. Figure 2-26 shows the seven banks and their associated supplies. Table 2-7 lists the maximum number of I/Os per bank for the whole LatticeSC family.

In the LatticeSC devices, single-ended output buffers and ratioed input buffers (LVTTTL, LVCMOS, PCI33 and PCIX33) are powered using V_{CCIO} . In addition to the bank V_{CCIO} supplies, the LatticeSC devices have a V_{CC} core logic power supply, and a V_{CCAUX} supply that power all differential and referenced buffers. V_{CCAUX} also powers a predriver of single-ended output buffers to enhance buffer performance.

Each bank can support up to two separate VREF voltages, V_{REF1} and V_{REF2} that set the threshold for the referenced input buffers. In the LatticeSC devices any I/O pin in a bank can be configured to be a dedicated reference voltage supply pin. Each I/O is individually configurable based on the bank's supply and reference voltages.

Differential drivers have user selectable internal or external bias. External bias is brought in by the V_{REF1} pin in the bank. External bias for differential buffers is needed for applications that requires tighter than standard output common mode range.

Since a bank can have only one external bias circuit for differential drivers, LVDS and RSDS differential outputs can be mixed in a bank.

If a differential driver is configured in a bank, one pin in that bank becomes a DIFFR pin. This DIFFR pin must be connected to ground via an external 1K +/-1% ohm resistor. Note that differential drivers are not supported in banks 1, 4 and 5.

In addition, there are dedicated Terminating Supply (V_{TT}) pins to be used as terminating voltage for one of the two ways to perform parallel terminations. These V_{TT} pins are available in banks 2-7, these pins are not available in some packages. When VTT termination is not required, or used to provide the common mode termination voltage (VCMT), these pins can be left unconnected on the device. If the internal or external VCMT function for differential input termination is used, the VTT pins should be unconnected and allowed to float.

There are further restrictions on the use of V_{TT} pins, for additional details refer to technical information at the end of this data sheet.

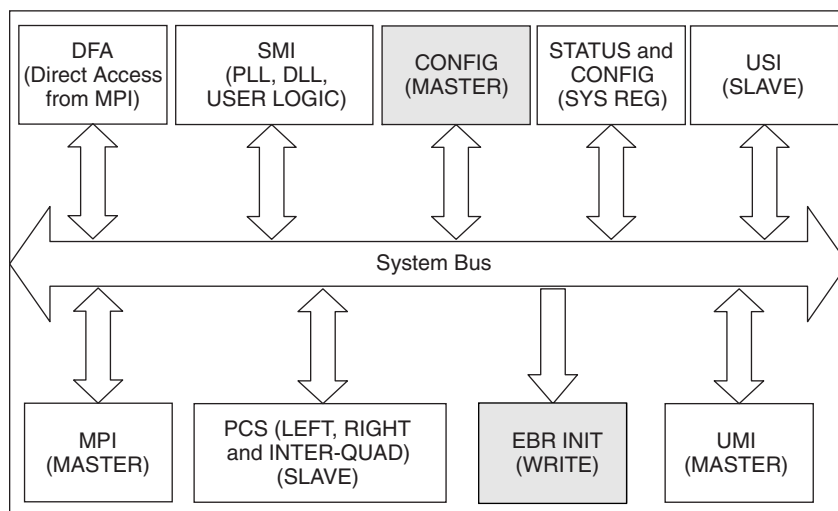
Table 2-9. Supported Input Standards

Input Standard	V _{REF} (Nom.)	V _{CCIO} ¹ (Nom.)	On-chip Termination
Single Ended Interfaces			
LVTTL33 ³	—	3.3	None
LVC MOS 33, 25, 18, 15, 12 ³	—	3.3/2.5/1.8/1.5/1.2	None
PCI33, PCIX33, AGP1X33 ³	—	3.3	None
PCIX15	0.75	1.5 ²	None / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
AGP2X33	1.32	—	None
HSTL18_I, II	0.9	1.8 ²	None / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
HSTL18_III, IV	1.08	1.8 ²	None / V _{CCIO} : 50
HSTL15_I, II	0.75	1.5 ²	None / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
HSTL15_III, IV	0.9	1.5 ²	None / V _{CCIO} : 50
SSTL33_I, II	1.5	3.3	None
SSTL25_I, II	1.25	2.5 ²	None / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
SSTL18_I, II	0.9	1.8 ²	None / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
GTL+, GTL	1.0 / 0.8	1.5 / 1.2 ²	None / V _{CCIO} : 50
Differential Interfaces			
SSTL18D_I, II	—	1.8 ²	None / Diff: 120, 150, 220, 420/ Diff to V _{CMT} : 120, 150, 220, 420 / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
SSTL25D_I, II	—	2.5 ²	None / Diff: 120, 150, 220, 420/ Diff to V _{CMT} : 120, 150, 220, 420 / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
SSTL33D_I, II	—	3.3	None
HSTL15D_I, II	—	1.5 ²	None / Diff: 120, 150, 220, 420/ Diff to V _{CMT} : 120, 150, 220, 420 / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
HSTL18D_I, II	—	1.8 ²	None / Diff: 120, 150, 220, 420/ Diff to V _{CMT} : 120, 150, 220, 420 / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
LVDS	—	—	None / Diff: 120, 150, 220, 240/ Diff to V _{CMT} : 120, 150, 220, 240
Mini-LVDS	—	—	None / Diff: 120, 150 / Diff to V _{CMT} : 120, 150
BLVDS25	—	—	None
MLVDS25	—	—	None
RSDS	—	—	None / Diff: 120, 150, 220, 240/ Diff to V _{CMT} : 120, 150, 220, 240
LVPECL33	—	≤2.5	None / Diff: 120, 150, 220, 240/ Diff to V _{CMT} : 120, 150, 220, 240

1. When not specified V_{CCIO} can be set anywhere in the valid operating range.

2. V_{CCIO} needed for on-chip termination to V_{CCIO}/2 or V_{CCIO} only. V_{CCIO} is not specified for off-chip termination or V_{TT} termination.

3. All ratioed input buffers and dedicated pin input buffers include hysteresis with a typical value of 50mV.

Figure 2-31. LatticeSC System Bus Interfaces

Several interfaces exist between the System Bus and other FPGA elements. The MPI interface acts as a bridge between the external microprocessor bus and System Bus. The MPI may work in an independent clock domain from the System Bus if the System Bus clock is not sourced from the external microprocessor clock. Pipelined operation allows high-speed memory interface to the EBR and peripheral access without the requirement for additional cycles on the bus. Burst transfers allow optimal use of the memory interface by giving advance information of the nature of the transfers.

Details for the majority of the peripherals can be found in the associated technical documentation, see details at the end of this data sheet. Additional details of the MPI are provided below.

Microprocessor Interface (MPI)

The LatticeSC family devices have a dedicated synchronous MPI function block. The MPI is programmable to operate with PowerPC/PowerQUICC MPC860/MPC8260 series microprocessors. The MPI implements an 8-, 16-, or 32-bit interface with 1-bit, 2-bit, or 4-bit parity to the host processor (PowerPC) that can be used for configuration and read-back of the FPGA as well as for user-defined data processing and general monitoring of FPGA functions.

The control portion of the MPI is available following power-up of the FPGA if the mode pins specify MPI mode, even if the FPGA is not yet configured. The width of the data port is selectable among 8-, 16-, or 32-bit and the parity bus can be 1-, 2-, or 4-bit. In configuration mode the data and parity bus width are related to the state of the M[0:3] mode pins. For post-configuration use, the MPI must be included in the configuration bit stream by using an MPI library element in your design from the ispLEVER primitive library, or by setting the bit of the MPI configuration control register prior to the start of configuration. The user can also enable and disable the parity bus through the configuration bit stream. These pads can be used as general I/O when they are not needed for MPI use.

The MPI block also provides the capability to interface directly to the FPGA fabric with a databus after configuration. The bus protocol is still handled by the MPI block but the direct FPGA access allows high-speed block data transfers such as DMA transactions. Figure 2-32 shows one of the ways a PowerPC is connected to MPI.

Input Delay Block/AIL Timing

Parameter	Description	Min.	Typ.	Max.	Units
t_{FDEL}	Fine delay time	35	45	80	ps
t_{CDEL}	Coarse delay time	1120	1440	2560	ps
j_{AIL}	AIL jitter tolerance	$1 - ((N + 1) * t_{FDEL}) / (\text{Clock Period})$			UI

1. N = number of fine delays used in a particular AIL setting

GSR Timing

Parameter	Description	VCC	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
$t_{SYNC_GSR_MAX}$	Maximum operating frequency for synchronous GSR	1.14V	—	438	—	417	—	398	MHz
		0.95V	—	378	—	355	—	337	MHz
$t_{ASYNC_GSR_MPW}$	Minimum pulse width of asynchronous input	—	—	—	—	—	3.3	—	ns

Note: Synchronous GSR goes out of reset in two cycles from the clock edge where the setup time of the FF was met.

Internal System Bus Timing

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t_{HCLK}	Maximum operating frequency for internal system bus HCLK.	—	200	—	200	—	200	MHz

Note: There is no minimum frequency. If HCLK is sourced from the embedded oscillator, the minimum frequency limitation of the oscillator/divider is about 0.3 MHz. Refer to the oscillator data for missing configuration modes.

sysCLOCK PLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)		2	—	1000	MHz
f_{OUT}	Output Clock Frequency (CLKOP, CLKOS)		1.5625	—	1000	MHz
f_{VCO}	PLL VCO Frequency		100	—	1000	MHz
f_{PFD}	Phase Detector Input Frequency		2	—	700	MHz
AC Characteristics						
t_{DT}	Output Clock Duty Cycle	Default duty cycle selected (at 50% levels)	45	—	55	%
t_{OPJIT}^1	Output Clock Period Jitter	$2\text{ MHz} \leq f_{PFD} \leq 10\text{ MHz}$	—	—	200	ps
		$f_{PFD} > 10\text{ MHz}$	—	—	100	ps
t_{CPJIT}^1	Output Clock Cycle-to-Cycle Jitter		—	—	100	ps
t_{SKEW}	Output Clock-to-Clock Skew (Between Two Outputs with the Same Phase Setting)		—	—	20	ps
t_{LOCK}	PLL Lock-in Time		—	—	1	ms
t_{IPJIT}	Input Clock Period Jitter		—	—	± 250	ps
t_{HI}	Input Clock High Time	At 80% level	350	—	—	ps
t_{LO}	Input Clock Low Time	At 20% level	350	—	—	ps
t_{RSWA}	Analog Reset Signal Pulse Width		100	—	—	ns
t_{RSWD}	Digital Reset Signal Pulse Width		3	—	—	ns
t_{DEL}	Timeshift Delay Step Size		40	80	120	ps
t_{RANGE}	Timeshift Delay Range		—	± 560	—	ps
f_{SS}	Spread Spectrum Modulation Frequency		30	—	500	KHz
% Spread	Percentage Downspread for SS Mode		0.5	—	1.5	%
	VCO Clock Phase Adjustment Accuracy		-5	—	5	°

1. Values are measured with FPGA logic active, no additional I/Os toggling and REFCLK total jitter = 30 ps

Pin Information Summary

Pin Type		256 fpBGA	900 fpBGA		1020 fcBGA	
		LFSC/M15	LFSC/M15	LFSC/M25	LFSC/M25	LFSC/M40
Single Ended User I/O		139	300	378	476	562
Differential Pair User I/O		60	141	182	235	277
LVDS Output Pairs		22	44	60	60	78
Configuration	Dedicated	9	11	11	11	11
	Muxes/MPI sysBus	0	55	55	55	72
JTAG (excluding VCCJ)		4	4	4	4	4
Dedicated Pins		2	4	4	4	4
VCC		10	46	46	40	40
VCC12		10	35	35	36	36
VCCAUX		10	36	36	32	32
VCCIO	Bank 1	3	18	18	10	10
	Bank 2	2	14	14	8	8
	Bank 3	2	15	15	10	10
	Bank 4	3	15	15	10	10
	Bank 5	3	15	15	10	10
	Bank 6	2	15	15	10	10
	Bank 7	2	16	16	8	8
VTT	Bank 2	0	2	2	2	2
	Bank 3	0	3	3	3	3
	Bank 4	0	3	3	3	3
	Bank 5	0	3	3	3	3
	Bank 6	0	3	3	3	3
	Bank 7	0	2	2	2	2
GND		26	177	177	134	134
NC		0	102	24	92	6
Single Ended User / Differential I/O per Bank	Bank 1	21/8	63/30	63/30	68/32	68/32
	Bank 2	15/7	26/13	30/15	34/17	54/27
	Bank 3	19/8	43/20	62/29	84/42	94/47
	Bank 4	25/11	50/22	66/32	84/41	99/48
	Bank 5	25/11	49/23	65/32	88/44	99/49
	Bank 6	19/8	43/20	62/29	84/42	94/47
	Bank 7	15/7	26/13	30/15	34/17	54/27
LVDS Output Pairs Per Bank	Bank 2	5	7	9	9	15
	Bank 3	6	15	21	21	24
	Bank 6	6	15	21	21	24
	Bank 7	5	7	9	9	15
VCCJ		1	1	1	1	1
SERDES (signal + power supply)		28	60	60	108	108
Total		256	900	900	1020	1152

LFSC/M15 Logic Signal Connections: 256 fpBGA^{1,2} (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
F14	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
E15	PR15B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
E14	PR15A	2	URC_PLLT_IN_A/URC_PLLT_FB_B
D9	VCCJ	-	
C16	TDO	-	TDO
B15	TMS	-	
B16	TCK	-	
E13	TDI	-	
C14	PROGRAMN	1	
C15	CCLK	1	
A15	PT43D	1	HDC/SI
A14	PT43C	1	LDCN/SCS
B14	PT41A	1	CS1
E12	PT39B	1	CS0N
D13	PT39A	1	RDN
D12	PT37D	1	WRN
E10	PT37C	1	D7
C11	PT37B	1	D6
D10	PT37A	1	D5
A13	PT36D	1	D4
B12	PT36C	1	D3
A12	PT35B	1	D2
C12	PT35A	1	D1
A11	PT33B	1	D0
B11	PT33A	1	QOUT/CEON
E9	PT32D	1	VREF2_1
E8	PT32B	1	DOUT
D8	PT28C	1	BUSYN/RCLK/SCK
A10	PT27B	1	PCLKC1_0
C10	PT27A	1	PCLKT1_0
E7	PT21C	1	VREF1_1
C9	A_VDDIB3_L	-	
A9	A_HDINP3_L	-	PCS 360 CH 3 IN P
B9	A_HDINN3_L	-	PCS 360 CH 3 IN N
A8	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
B8	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
C8	A_VDDOB3_L	-	
B7	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
C7	A_VDDOB2_L	-	
A7	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
B6	A_HDINN2_L	-	PCS 360 CH 2 IN N
A6	A_HDINP2_L	-	PCS 360 CH 2 IN P
C6	A_VDDIB2_L	-	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2}

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
F7	A_VDDAX25_L	-		A_VDDAX25_L	-	
B1	A_REFCLKP_L	-		A_REFCLKP_L	-	
C1	A_REFCLKN_L	-		A_REFCLKN_L	-	
D5	VCC12	-		VCC12	-	
A2	RESP_ULC	-		RESP_ULC	-	
E5	VCC12	-		VCC12	-	
D4	VCC12	-		VCC12	-	
H5	RESETN	1		RESETN	1	
H6	TSALLN	1		TSALLN	1	
G6	DONE	1		DONE	1	
G5	INITN	1		INITN	1	
F5	M0	1		M0	1	
F6	M1	1		M1	1	
F4	M2	1		M2	1	
E4	M3	1		M3	1	
D3	PL15A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B	PL16A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B
D2	PL15B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B	PL16B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B
J6	PL15C	7		PL16C	7	
J5	PL15D	7		PL16D	7	
E3	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D
E2	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D
K4	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A
J4	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A
F3	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C
G3	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C
K5	PL18C	7		PL18C	7	
K6	PL18D	7	VREF2_7	PL18D	7	VREF2_7
F2	PL19A	7		PL22A	7	
F1	PL19B	7		PL22B	7	
E1	PL19C	7		PL22C	7	
D1	PL19D	7		PL22D	7	
K3	PL22A	7		PL25A	7	
L3	PL22B	7		PL25B	7	
L6	PL22C	7	VREF1_7	PL25C	7	VREF1_7
M6	PL22D	7	DIFFR_7	PL25D	7	DIFFR_7
J1	PL23A	7	PCLKT7_1	PL26A	7	PCLKT7_1
K1	PL23B	7	PCLKC7_1	PL26B	7	PCLKC7_1
L1	PL24A	7	PCLKT7_0	PL27A	7	PCLKT7_0
M1	PL24B	7	PCLKC7_0	PL27B	7	PCLKC7_0
P8	PL24C	7	PCLKT7_2	PL27C	7	PCLKT7_2
R8	PL24D	7	PCLKC7_2	PL27D	7	PCLKC7_2
N2	PL26A	6	PCLKT6_0	PL29A	6	PCLKT6_0
N1	PL26B	6	PCLKC6_0	PL29B	6	PCLKC6_0
R7	PL26C	6	PCLKT6_1	PL29C	6	PCLKT6_1
R6	PL26D	6	PCLKC6_1	PL29D	6	PCLKC6_1

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AK14	PB25A	5		PB35A	5	
AK15	PB25B	5		PB35B	5	
AK16	PB27A	4		PB37A	4	
AK17	PB27B	4		PB37B	4	
AJ16	PB28A	4		PB38A	4	
AJ17	PB28B	4		PB38B	4	
AE16	PB28C	4		PB38C	4	
AH16	PB29A	4		PB39A	4	
AG16	PB29B	4		PB39B	4	
AK18	PB31A	4		PB41A	4	
AK19	PB31B	4		PB41B	4	
AH17	PB32A	4		PB42A	4	
AH18	PB32B	4		PB42B	4	
AG17	PB32D	4		PB42D	4	
AJ18	PB33A	4		PB43A	4	
AJ19	PB33B	4		PB43B	4	
AK20	PB35A	4	PCLKT4_2	PB46A	4	PCLKT4_2
AK21	PB35B	4	PCLKC4_2	PB46B	4	PCLKC4_2
AF18	PB36A	4	PCLKT4_1	PB47A	4	PCLKT4_1
AG18	PB36B	4	PCLKC4_1	PB47B	4	PCLKC4_1
AJ20	PB37A	4	PCLKT4_0	PB49A	4	PCLKT4_0
AJ21	PB37B	4	PCLKC4_0	PB49B	4	PCLKC4_0
AG19	PB37C	4	VREF2_4	PB49C	4	VREF2_4
AK22	PB39A	4	PCLKT4_5	PB51A	4	PCLKT4_5
AK23	PB39B	4	PCLKC4_5	PB51B	4	PCLKC4_5
AH19	PB39C	4		PB51C	4	
AK24	PB40A	4	PCLKT4_3	PB52A	4	PCLKT4_3
AK25	PB40B	4	PCLKC4_3	PB52B	4	PCLKC4_3
AE19	PB40C	4	PCLKT4_4	PB52C	4	PCLKT4_4
AE20	PB40D	4	PCLKC4_4	PB52D	4	PCLKC4_4
AE21	PB41A	4		PB53A	4	
AF21	PB41B	4		PB53B	4	
AG21	PB43A	4		PB55A	4	
AG22	PB43B	4		PB55B	4	
AH22	PB44A	4		PB56A	4	
AH23	PB44B	4		PB56B	4	
AH21	PB44C	4		PB56C	4	
AK28	PB45A	4		PB60A	4	
AK29	PB45B	4		PB60B	4	
AE22	PB45C	4		PB60C	4	
AJ28	PB47A	4		PB67A	4	
AH28	PB47B	4		PB67B	4	
AE24	PB47C	4	VREF1_4	PB67C	4	VREF1_4
AE25	PB47D	4		PB67D	4	
AJ29	PB48A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D	PB68A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AG11	VCCIO5	-		VCCIO5	-	
AJ9	VCCIO5	-		VCCIO5	-	
AJ23	VCCIO4	-		VCCIO4	-	
AG20	VCCIO4	-		VCCIO4	-	
AJ26	VCCIO4	-		VCCIO4	-	
AG23	VCCIO4	-		VCCIO4	-	
AC29	VCCIO3	-		VCCIO3	-	
AA26	VCCIO3	-		VCCIO3	-	
Y28	VCCIO3	-		VCCIO3	-	
AA29	VCCIO3	-		VCCIO3	-	
G30	VCCIO2	-		VCCIO2	-	
J29	VCCIO2	-		VCCIO2	-	
K27	VCCIO2	-		VCCIO2	-	
N25	VCCIO2	-		VCCIO2	-	
F20	VCCIO1	-		VCCIO1	-	
C19	VCCIO1	-		VCCIO1	-	
C12	VCCIO1	-		VCCIO1	-	
F11	VCCIO1	-		VCCIO1	-	
H1	GND	-		GND	-	
L4	GND	-		GND	-	
M3	GND	-		GND	-	
N5	GND	-		GND	-	
K2	GND	-		GND	-	
M2	GND	-		GND	-	
P6	GND	-		GND	-	
G4	GND	-		GND	-	
H3	GND	-		GND	-	
AC2	GND	-		GND	-	
AA3	GND	-		GND	-	
AE1	GND	-		GND	-	
Y4	GND	-		GND	-	
AB4	GND	-		GND	-	
AA5	GND	-		GND	-	
AE6	GND	-		GND	-	
AE8	GND	-		GND	-	
AH5	GND	-		GND	-	
AG9	GND	-		GND	-	
AG6	GND	-		GND	-	
AF11	GND	-		GND	-	
AG12	GND	-		GND	-	
AJ10	GND	-		GND	-	
AK26	GND	-		GND	-	
AJ22	GND	-		GND	-	
AF20	GND	-		GND	-	
AJ25	GND	-		GND	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
B30	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
D30	A_VDDOB0_L	-		A_VDDOB0_L	-	
A30	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
C31	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
C32	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
B31	A_VDDIB0_L	-		A_VDDIB0_L	-	
AL25	NC	-		PB26A	5	
AL24	NC	-		PB26B	5	
AG27	NC	-		PB26C	5	
AH27	NC	-		PB26D	5	
AM25	NC	-		PB27A	5	
AM24	NC	-		PB27B	5	
AL9	NC	-		PB62A	4	
AL8	NC	-		PB62B	4	
AK9	NC	-		PB63A	4	
AJ9	NC	-		PB63B	4	
AG10	NC	-		PB63C	4	
AG11	NC	-		PB63D	4	
J30	NC	-		PL26A	7	
H30	NC	-		PL26B	7	
M28	NC	-		PL26C	7	
N28	NC	-		PL26D	7	
J32	NC	-		PL27A	7	
J31	NC	-		PL27B	7	
N26	NC	-		PL27C	7	
N27	NC	-		PL27D	7	
K31	NC	-		PL29A	7	
K32	NC	-		PL29B	7	
P25	NC	-		PL29C	7	
P26	NC	-		PL29D	7	
L27	NC	-		PL22C	7	
L28	NC	-		PL22D	7	
M29	NC	-		PL30A	7	
L29	NC	-		PL30B	7	
M30	NC	-		PL31A	7	
L30	NC	-		PL31B	7	
L31	NC	-		PL34A	7	
M31	NC	-		PL34B	7	
AA29	NC	-		PL56A	6	
AA30	NC	-		PL56B	6	
AB31	NC	-		PL57A	6	
AA31	NC	-		PL57B	6	
AG30	NC	-		PL57C	6	
AG29	NC	-		PL57D	6	
AB29	NC	-		PL58A	6	
AB30	NC	-		PL58B	6	
Y25	NC	-		PL58C	6	
AA25	NC	-		PL58D	6	
AA8	NC	-		PR58D	3	
Y8	NC	-		PR58C	3	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AF21	PB26D	5		PB29D	5	
AN23	PB27A	5		PB45A	5	
AN22	PB27B	5		PB45B	5	
AP23	PB29A	5		PB55A	5	
AP22	PB29B	5		PB55B	5	
AG21	PB29C	5		PB55C	5	
AG20	PB29D	5		PB55D	5	
AP25	PB30A	5	PCLKT5_3	PB48A	5	PCLKT5_3
AP24	PB30B	5	PCLKC5_3	PB48B	5	PCLKC5_3
AD21	PB30C	5	PCLKT5_4	PB48C	5	PCLKT5_4
AD20	PB30D	5	PCLKC5_4	PB48D	5	PCLKC5_4
AL23	PB31A	5	PCLKT5_5	PB49A	5	PCLKT5_5
AL22	PB31B	5	PCLKC5_5	PB49B	5	PCLKC5_5
AH24	PB31C	5		PB49C	5	
AH23	PB31D	5		PB49D	5	
AM23	PB33A	5	PCLKT5_0	PB51A	5	PCLKT5_0
AM22	PB33B	5	PCLKC5_0	PB51B	5	PCLKC5_0
AJ24	PB33C	5		PB51C	5	
AJ23	PB33D	5	VREF2_5	PB51D	5	VREF2_5
AN21	PB34A	5	PCLKT5_1	PB52A	5	PCLKT5_1
AN20	PB34B	5	PCLKC5_1	PB52B	5	PCLKC5_1
AE19	PB34C	5	PCLKT5_6	PB52C	5	PCLKT5_6
AD19	PB34D	5	PCLKC5_6	PB52D	5	PCLKC5_6
AK21	PB35A	5	PCLKT5_2	PB53A	5	PCLKT5_2
AK20	PB35B	5	PCLKC5_2	PB53B	5	PCLKC5_2
AK23	PB35C	5	PCLKT5_7	PB53C	5	PCLKT5_7
AK22	PB35D	5	PCLKC5_7	PB53D	5	PCLKC5_7
AL20	PB37A	5		PB56A	5	
AL19	PB37B	5		PB56B	5	
AG19	PB37C	5		PB56C	5	
AF19	PB37D	5		PB56D	5	
AP21	PB38A	5		PB57A	5	
AP20	PB38B	5		PB57B	5	
AH21	PB38C	5		PB57C	5	
AH20	PB38D	5		PB57D	5	
AM20	PB39A	5		PB59A	5	
AM19	PB39B	5		PB59B	5	
AJ21	PB39C	5		PB59C	5	
AJ20	PB39D	5		PB59D	5	
AK19	PB41A	5		PB60A	5	
AK18	PB41B	5		PB60B	5	
AE18	PB41C	5		PB60C	5	
AD18	PB41D	5		PB60D	5	
AN19	PB42A	5		PB61A	5	
AN18	PB42B	5		PB61B	5	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
L1	PR31A	2		PR43A	2	
T10	PR30D	2		PR42D	2	
U10	PR30C	2		PR42C	2	
N2	PR30B	2		PR42B	2	
M2	PR30A	2		PR42A	2	
R11	PR29D	2		PR37D	2	
P11	PR29C	2		PR37C	2	
N4	PR29B	2		PR37B	2	
M4	PR29A	2		PR37A	2	
N5	PR27D	2		PR35D	2	
M5	PR27C	2		PR35C	2	
L2	PR27B	2		PR35B	2	
K2	PR27A	2		PR35A	2	
P8	PR26D	2		PR33D	2	
N8	PR26C	2		PR33C	2	
J2	PR26B	2		PR33B	2	
H2	PR26A	2		PR33A	2	
M6	PR25D	2		PR31D	2	
L6	PR25C	2		PR31C	2	
K3	PR25B	2		PR31B	2	
J3	PR25A	2		PR31A	2	
M8	PR23D	2	DIFFR_2	PR29D	2	DIFFR_2
L8	PR23C	2	VREF1_2	PR29C	2	VREF1_2
K4	PR23B	2		PR29B	2	
J4	PR23A	2		PR29A	2	
M7	PR22D	2		PR21D	2	
L7	PR22C	2		PR21C	2	
J5	PR22B	2		PR21B	2	
H5	PR22A	2		PR21A	2	
N9	PR21D	2		PR20D	2	
P9	PR21C	2		PR20C	2	
G3	PR21B	2		PR20B	2	
F3	PR21A	2		PR20A	2	
J6	PR18D	2	VREF2_2	PR18D	2	VREF2_2
H6	PR18C	2		PR18C	2	
E2	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C
D2	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C
P10	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A
N10	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A
G4	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D
F4	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
J7	PR16D	2		PR16D	2	
H7	PR16C	2		PR16C	2	
G5	PR16B	2	URC_PLLC_IN_A/URC_PLLC_FB_B	PR16B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
F5	PR16A	2	URC_PLLT_IN_A/URC_PLLT_FB_B	PR16A	2	URC_PLLT_IN_A/URC_PLLT_FB_B

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AJ34	PL98A	6	
AK34	PL98B	6	
AB27	PL98C	6	
AC27	PL98D	6	
AF33	PL99A	6	
AG33	PL99B	6	
AC29	PL99C	6	
AD29	PL99D	6	
AE31	PL103A	6	
AF31	PL103B	6	
AF30	PL103C	6	
AF29	PL103D	6	
AH33	PL104A	6	
AJ33	PL104B	6	
AC28	PL104C	6	
AD28	PL104D	6	
AH32	PL107A	6	
AJ32	PL107B	6	
AD27	PL107C	6	
AE27	PL107D	6	VREF2_6
AG34	PL109A	6	
AH34	PL109B	6	
AC26	PL109C	6	
AB26	PL109D	6	
AK33	PL112A	6	
AL33	PL112B	6	
AG30	PL112C	6	
AH30	PL112D	6	
AL34	PL115A	6	
AM34	PL115B	6	
AJ30	PL115C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F
AK30	PL115D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F
AJ31	PL116A	6	
AH31	PL116B	6	
AD26	PL116C	6	
AD25	PL116D	6	
AL32	PL117A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E
AL31	PL117B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E
AG29	PL117C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A
AG28	PL117D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A
AF28	XRES	-	
AF27	TEMP	6	
AM33	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
L21	PT55D	1	A16/MPI_ADDR30
L20	PT55C	1	D13/MPI_DATA13
D20	PT55B	1	A15/MPI_ADDR29
E20	PT55A	1	A17/MPI_ADDR31
L19	PT54D	1	A19/MPI_TSI21
K19	PT54C	1	A20/MPI_BDIP
D21	PT54B	1	A18/MPI_TSI20
E21	PT54A	1	MPI_TEA
M20	PT51D	1	D14/MPI_DATA14
M19	PT51C	1	DP1/MPI_PAR1
F21	PT51B	1	A21/MPI_BURST
G21	PT51A	1	D15/MPI_DATA15
H24	B_REFCLKP_L	-	
J24	B_REFCLKN_L	-	
L22	VCC12	-	
E26	B_VDDIB3_L	-	
G22	VCC12	-	
E22	B_HDINP3_L	-	PCS 361 CH 3 IN P
F22	B_HDINN3_L	-	PCS 361 CH 3 IN N
A21	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P
L24	VCC12	-	
B21	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N
D22	B_VDDOB3_L	-	
B22	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N
D23	B_VDDOB2_L	-	
A22	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P
K24	VCC12	-	
F23	B_HDINN2_L	-	PCS 361 CH 2 IN N
E23	B_HDINP2_L	-	PCS 361 CH 2 IN P
D26	B_VDDIB2_L	-	
G23	VCC12	-	
D27	B_VDDIB1_L	-	
G24	VCC12	-	
E24	B_HDINP1_L	-	PCS 361 CH 1 IN P
F24	B_HDINN1_L	-	PCS 361 CH 1 IN N
A23	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P
L25	VCC12	-	
B23	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N
D24	B_VDDOB1_L	-	
B24	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N
D25	B_VDDOB0_L	-	
A24	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P
K25	VCC12	-	

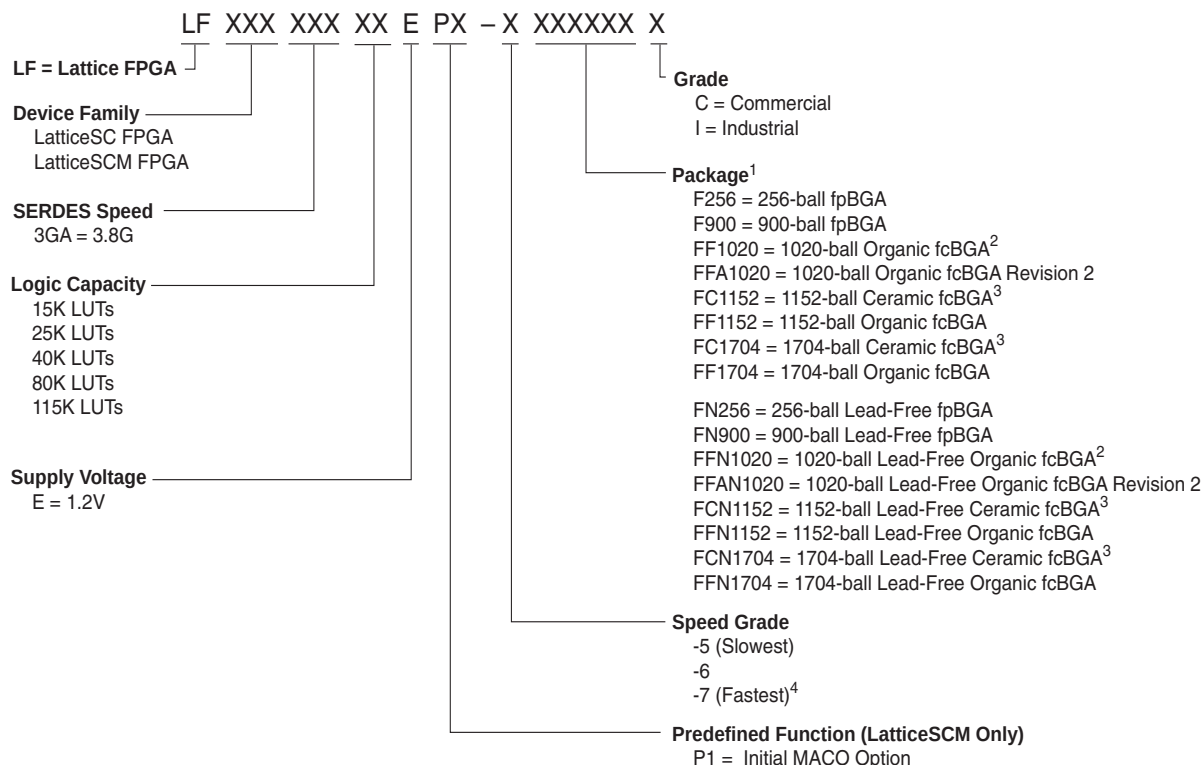
LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
W7	GND	-	
AA14	VCC	-	
AA16	VCC	-	
AA17	VCC	-	
AA18	VCC	-	
AA19	VCC	-	
AA21	VCC	-	
AB13	VCC	-	
AB22	VCC	-	
N13	VCC	-	
N22	VCC	-	
P14	VCC	-	
P16	VCC	-	
P17	VCC	-	
P18	VCC	-	
P19	VCC	-	
P21	VCC	-	
R15	VCC	-	
R17	VCC	-	
R18	VCC	-	
R20	VCC	-	
T14	VCC	-	
T16	VCC	-	
T19	VCC	-	
T21	VCC	-	
U14	VCC	-	
U15	VCC	-	
U17	VCC	-	
U18	VCC	-	
U20	VCC	-	
U21	VCC	-	
V14	VCC	-	
V15	VCC	-	
V17	VCC	-	
V18	VCC	-	
V20	VCC	-	
V21	VCC	-	
W14	VCC	-	
W16	VCC	-	
W19	VCC	-	
W21	VCC	-	
Y15	VCC	-	
Y17	VCC	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AM27	GND	-		GND	-	
AM36	GND	-		GND	-	
AM7	GND	-		GND	-	
AP4	GND	-		GND	-	
AP40	GND	-		GND	-	
AR14	GND	-		GND	-	
AR20	GND	-		GND	-	
AR23	GND	-		GND	-	
AR29	GND	-		GND	-	
AR35	GND	-		GND	-	
AR8	GND	-		GND	-	
AT11	GND	-		GND	-	
AT17	GND	-		GND	-	
AT26	GND	-		GND	-	
AT32	GND	-		GND	-	
AU3	GND	-		GND	-	
AU39	GND	-		GND	-	
AW12	GND	-		GND	-	
AW18	GND	-		GND	-	
AW22	GND	-		GND	-	
AW28	GND	-		GND	-	
AW34	GND	-		GND	-	
AW6	GND	-		GND	-	
AY15	GND	-		GND	-	
AY21	GND	-		GND	-	
AY25	GND	-		GND	-	
AY31	GND	-		GND	-	
AY37	GND	-		GND	-	
AY9	GND	-		GND	-	
B1	GND	-		GND	-	
B42	GND	-		GND	-	
BA1	GND	-		GND	-	
BA42	GND	-		GND	-	
BB2	GND	-		GND	-	
BB41	GND	-		GND	-	
C10	GND	-		GND	-	
C12	GND	-		GND	-	
C13	GND	-		GND	-	
C16	GND	-		GND	-	
C18	GND	-		GND	-	
C19	GND	-		GND	-	
C22	GND	-		GND	-	
C24	GND	-		GND	-	
C27	GND	-		GND	-	
C28	GND	-		GND	-	

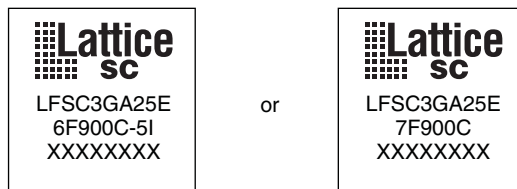
Part Number Description



1. fpBGA = 1.0 mm pitch BGA, fcBGA = 1.0 mm flip-chip BGA (organic and ceramic).
2. Converted to organic fcBGA per PCN #02A-10.
3. Converted to organic fcBGA per PCN #01A-10.
4. Not available in the LatticeSC115 and LatticeSCM115 devices.

Ordering Information

Depending on the speed and temperature grade, the device can either be dual marked or single marked. The commercial grade is one speed grade faster than the associated dual marked industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:



Temperature Grade	Speed Grade	Single or Dual Mark?
Commercial	-7	Either OK
	-6	Dual Only
	-5	Single Only
Industrial	-6	Either OK
	-5	Dual Only

Date	Version	Section	Change Summary
February 2006	01.0	—	Initial release.
March 2006	01.1	Introduction	SC25 1020 I/O count changed to 476.
		Architecture	Changed ROM 16X4 to ROM 16X2.
			Changed “X2 or X4” to “DIV2 or DIV4”.
			Added Global Set/Reset Section.
		DC and Switching Characteristics	Added notes 5 and 6 to Recommended Operating Conditions table.
			Added Power Supply Ramp Rates table.
			Removed -5 and -6 speed grades from Typical Building Block Performance table.
			Added Input Delay Timing table.
			Added Synchronous GSR Timing table.
		Pinout Information	Expanded PROBE_VCC and PROBE_GND description.
			Removed A-RXREFCLKP_[L/R] from Signal Description table.
			Added RESP_[ULC/URC] to Signal Description table.
			Added notes 1 and 2 to Signal Description table.
			Changed number of NCs to 28.
			Changed number of SERDES (signal + power supply) to 74.
			Removed RESP balls from NC list (B2, C2, B29, C29).
			Added note to VTT table.
			Changed RxRefclk (B2 and C2) to NC.
			Added RESP_ULC.
			Added RESP_URC.
			Changed RxRefclk (B29 and C29) to NC.
June 2006	01.2	Introduction	Changed SERDES min bandwidth from 622 Mbps to 600 Mbps.
			Changed max SERDES bandwidth from 3.4 Gbps to 3.8 Gbps.
			Corrected number of package I/Os for the SC80 and SC115 1704 pin packages.
			Updated speed performance for typical functions with ispLEVER 6.0 values.
		Architecture	Changed “When these pins are not used they should be left unconnected.” with “Unused VTT pins should be connected to GND if the internal or external VCMT function is not used in the bank. If the internal or external VCMT function for differential input termination is used, the VTT pins should be unconnected and allowed to float.”
			Added “SERDES Power Supply Sequencing Requirements” section.
			Changed total bandwidth per quad from 13.6 Gbps to 15.2 Gbps.
			Added the accuracy of the temperature-sensing diode to be typically +/- 10 °C. Also referred to a temperature-sensing diode application note for more information.
		DC and Switching Characteristics	Changed “CTAP” to “internal or external VCMT”.
			Changed VCC12 parameter to include VDDP, VDDTX and VDDRFX.
			Changed typical values to match ispLEVER 6.0 Power Calculator.